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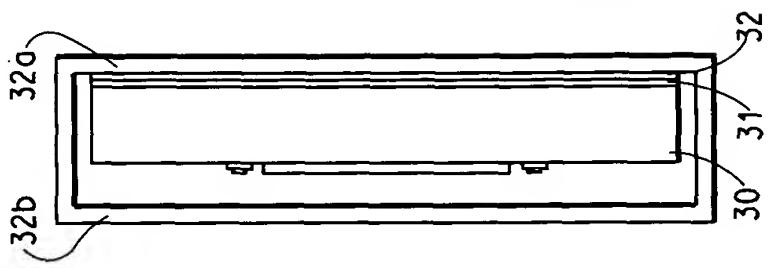


FIG. 3B

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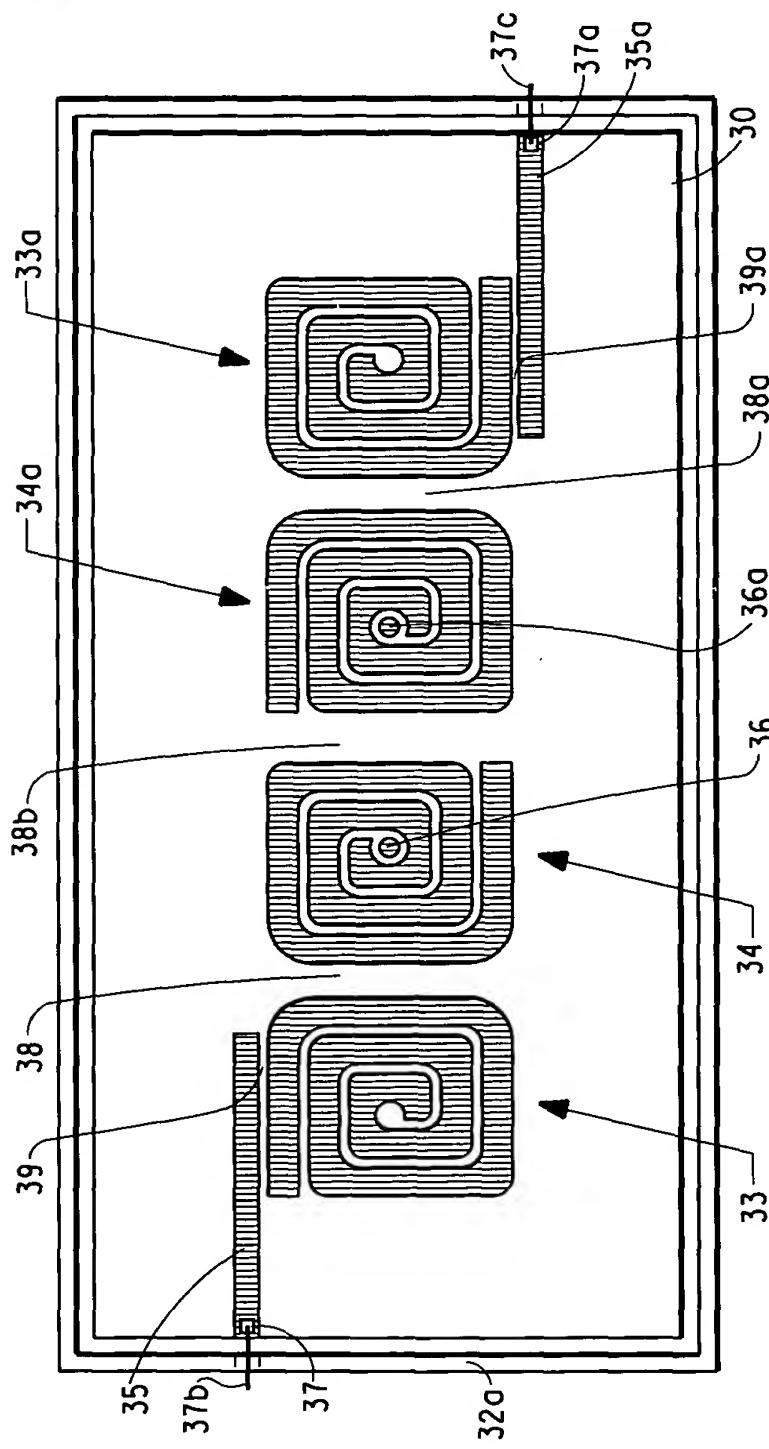


FIG. 3A

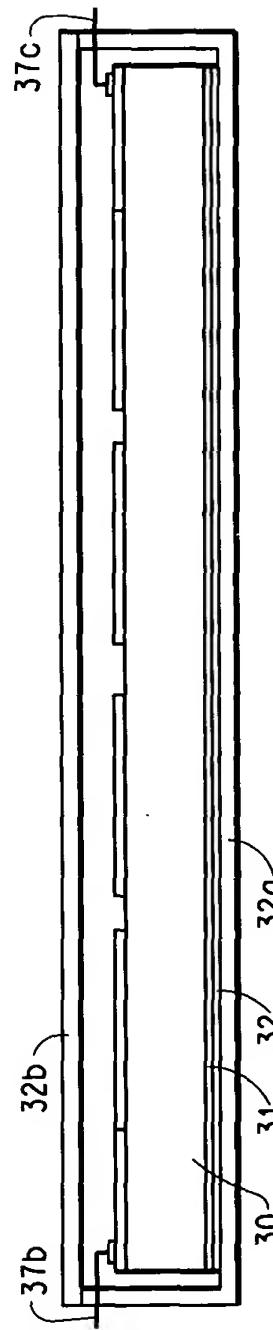


FIG. 3C



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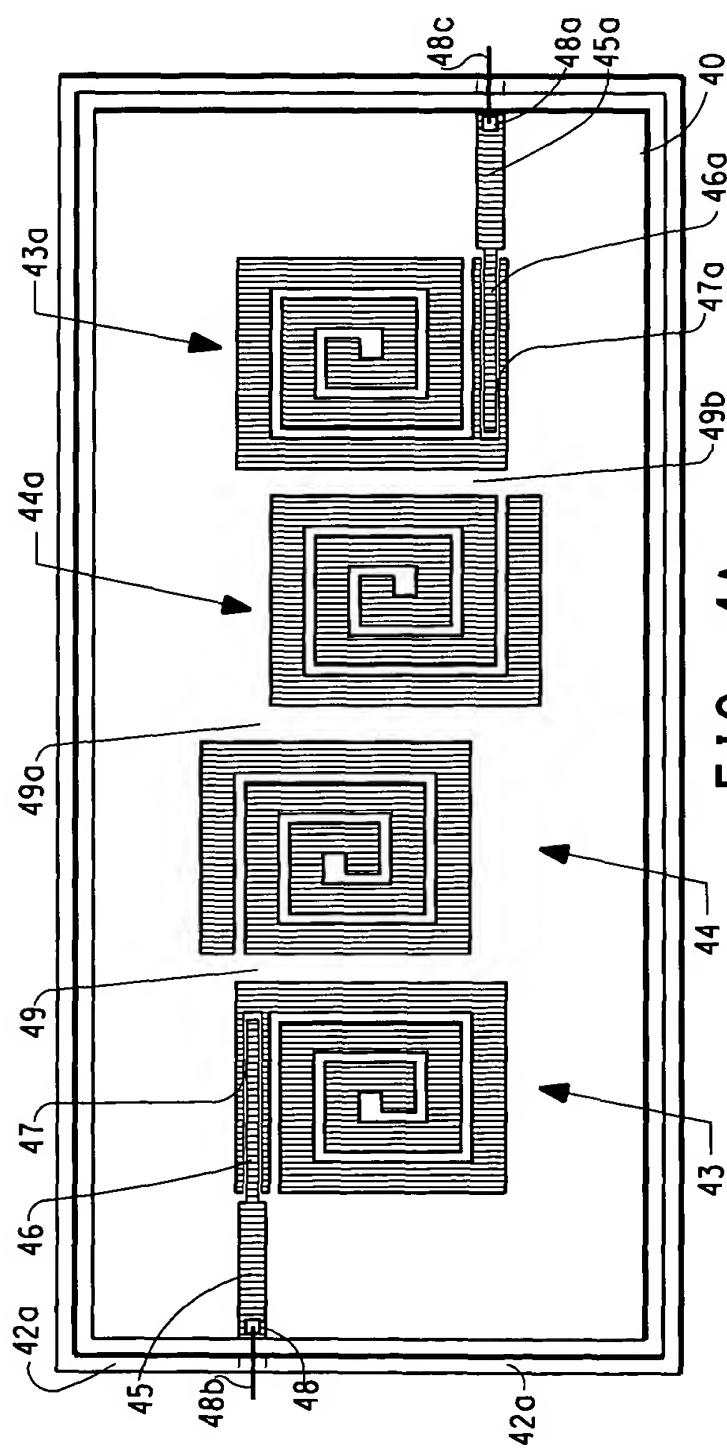
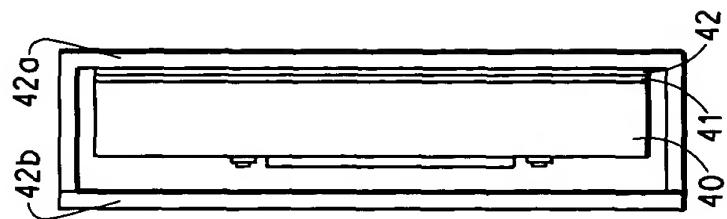


FIG. 4B

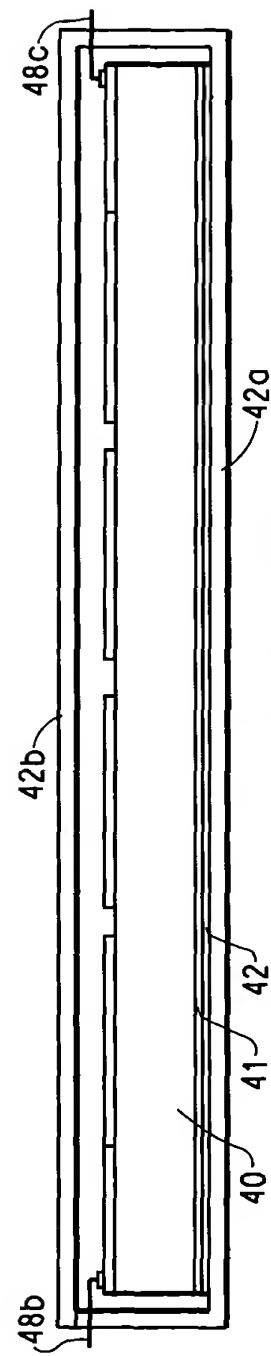


FIG. 4C

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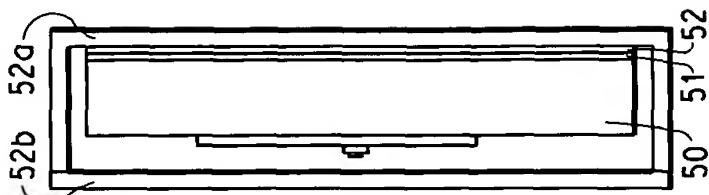
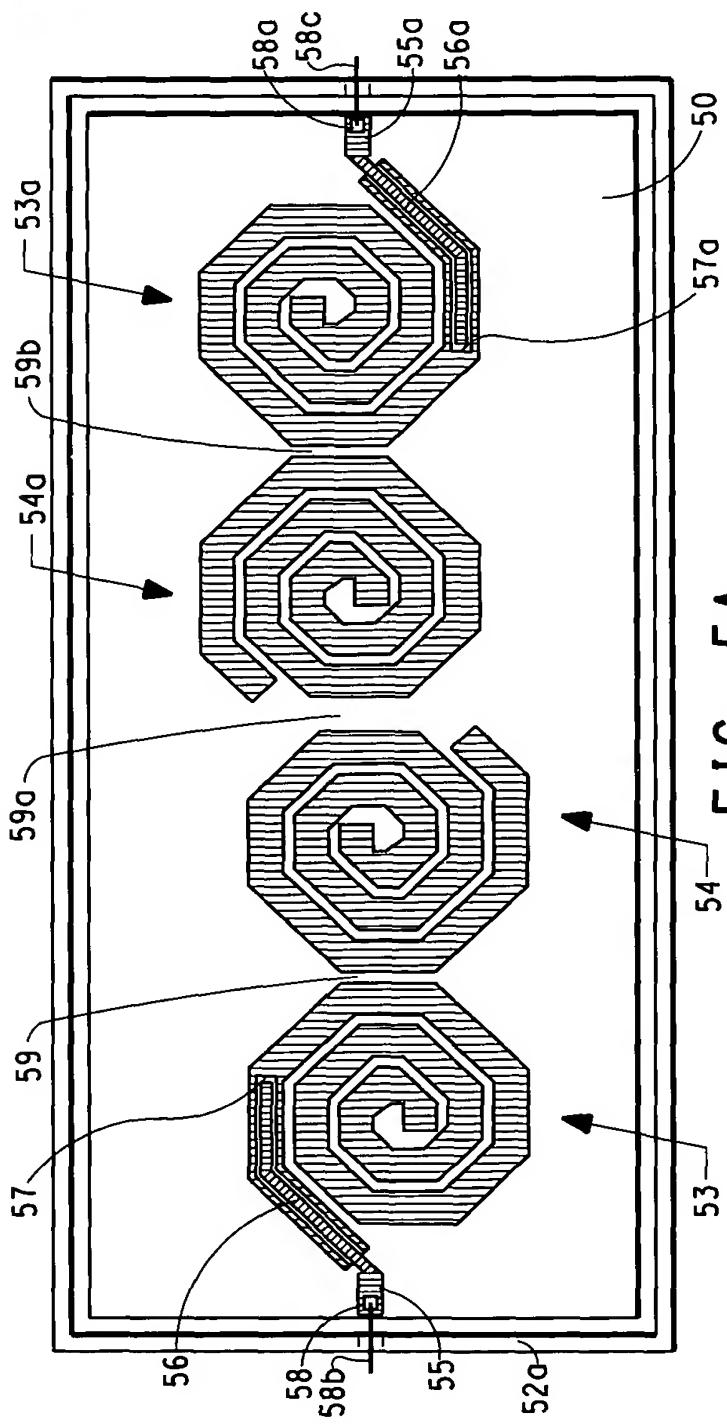


FIG. 5B



54 FIG. 5A

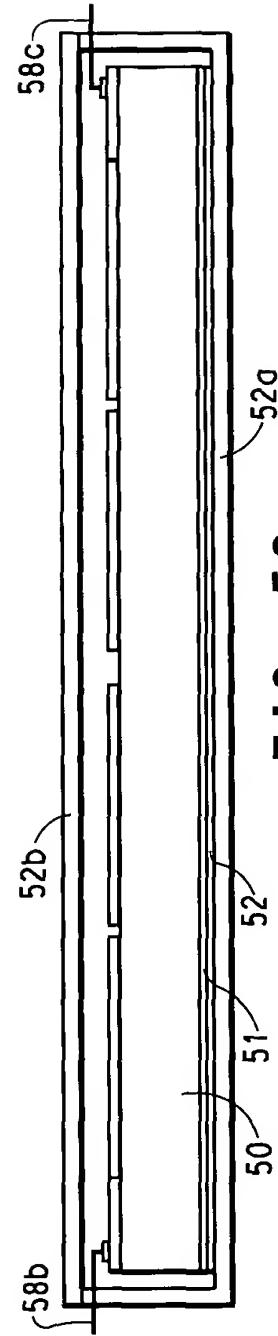


FIG. 5C

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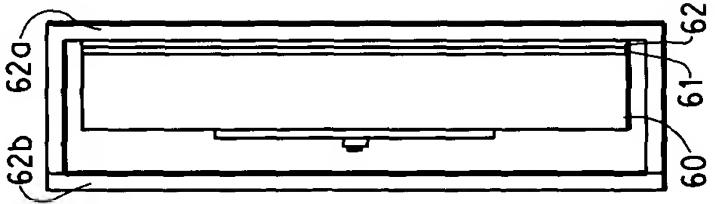


FIG. 6B

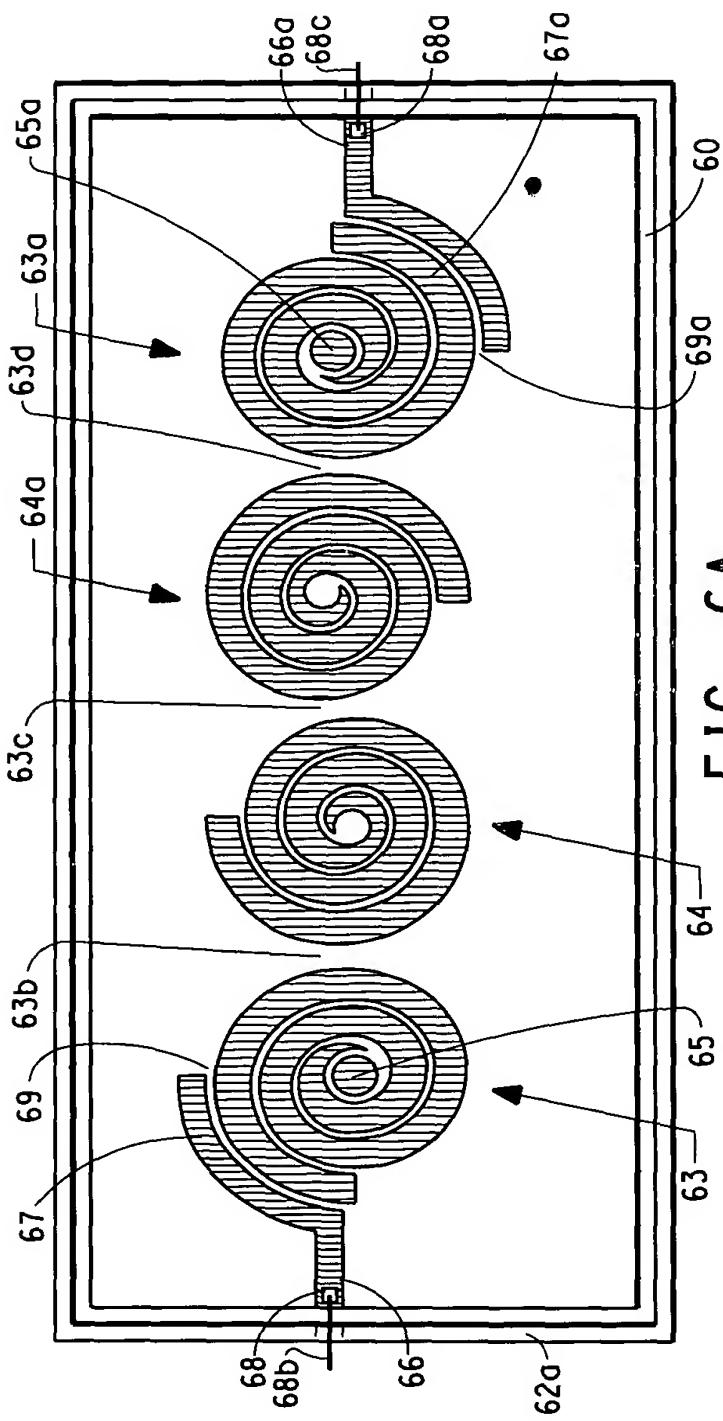


FIG. 6A

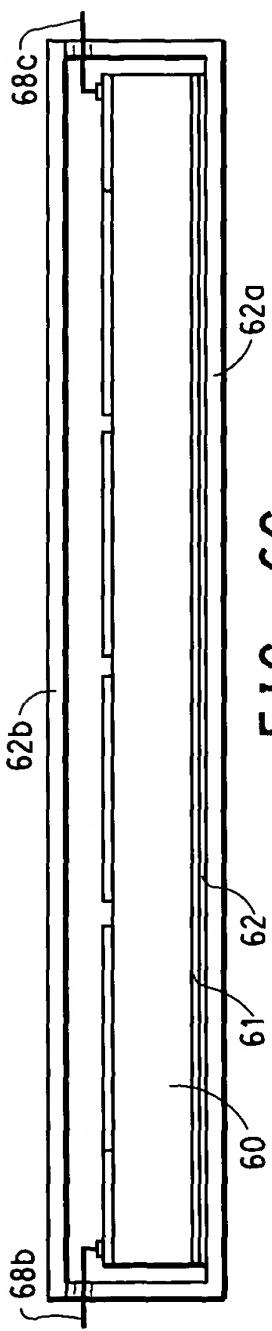


FIG. 6C



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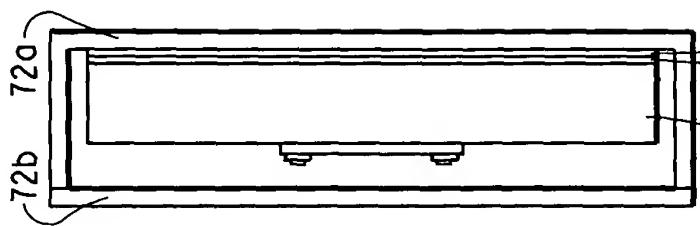


FIG. 7B

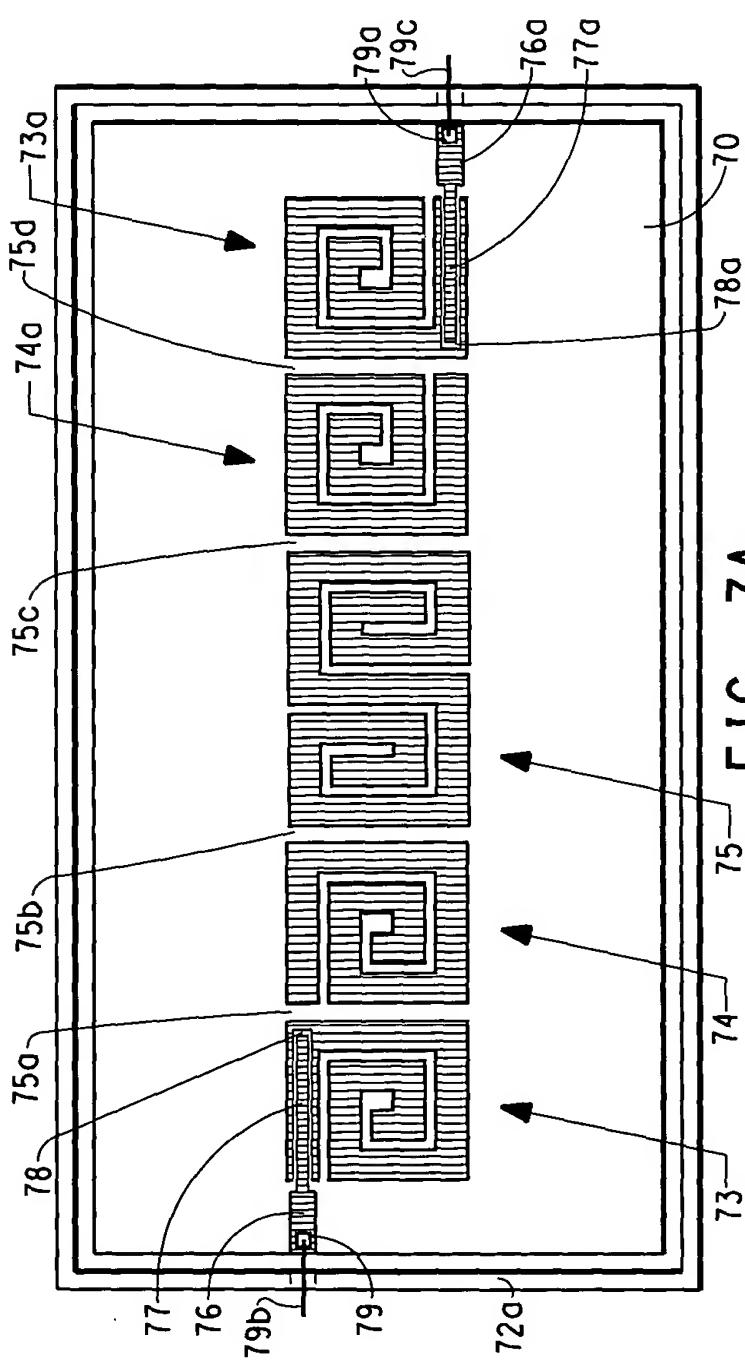


FIG. 7A

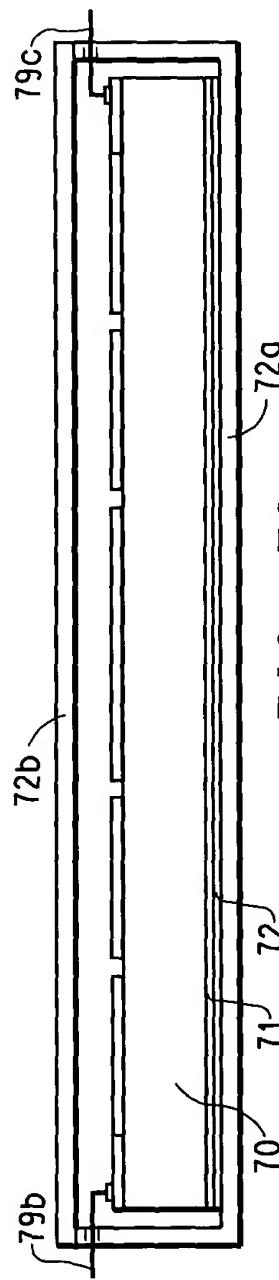
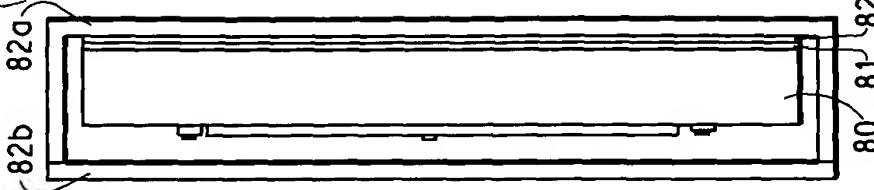


FIG. 7C



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FIG. 8B



890a

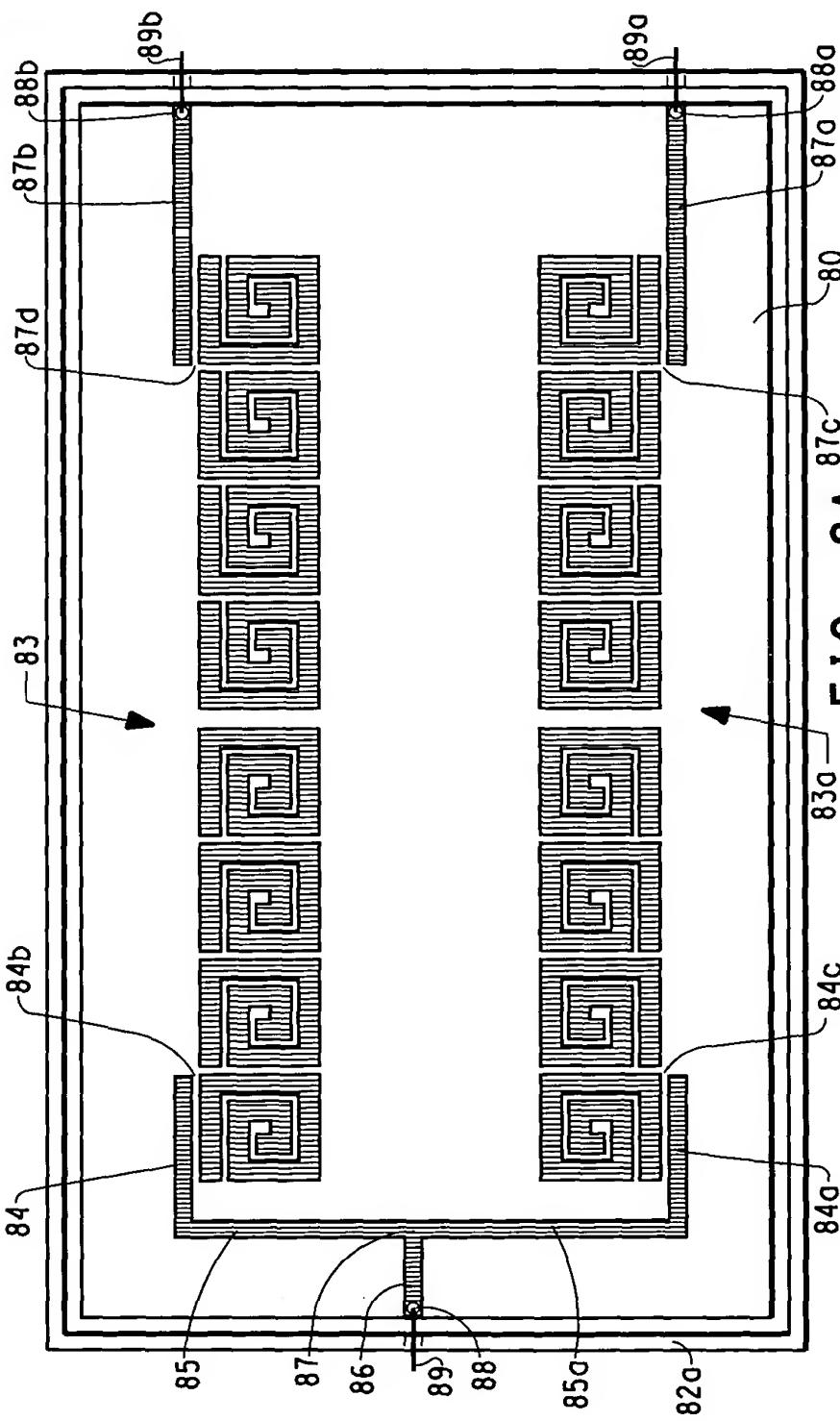
820

81, 82, f

89, 82b, 110.10a

89

FIG. 8C





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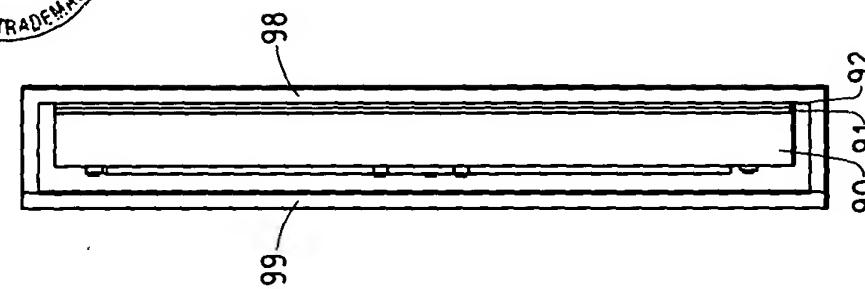


FIG. 9B

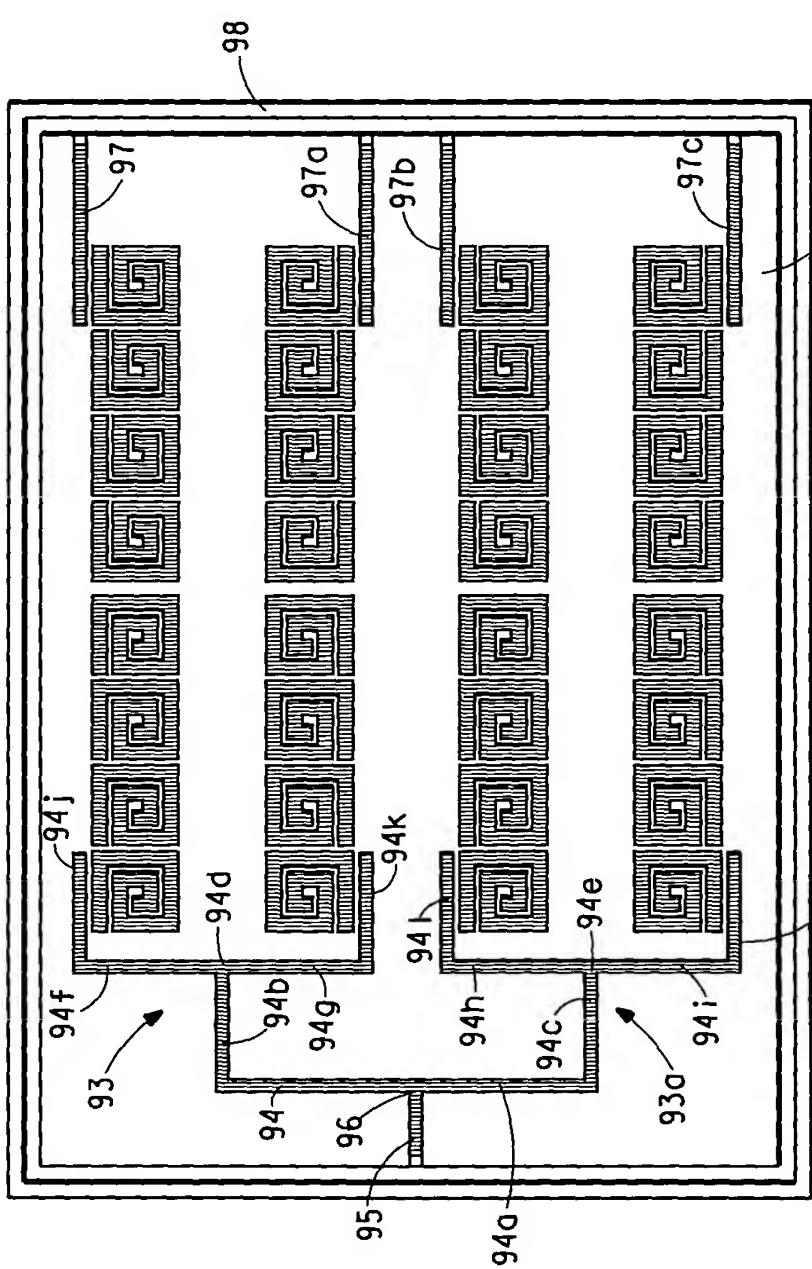


FIG. 9A

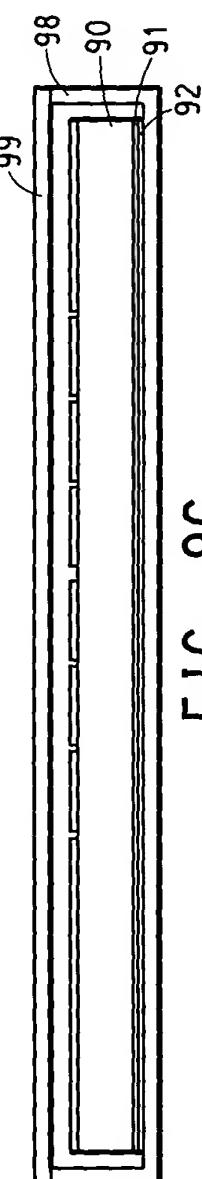


FIG. 9C

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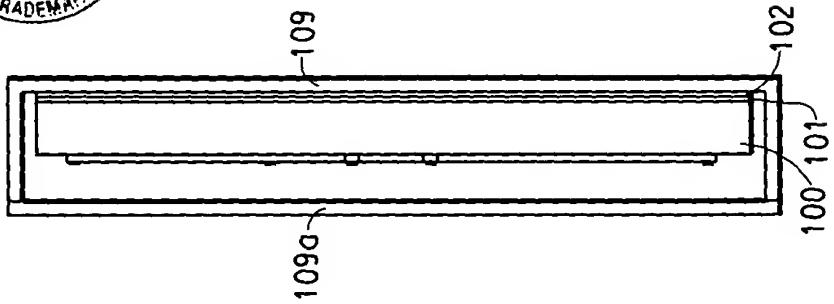


FIG. 10B

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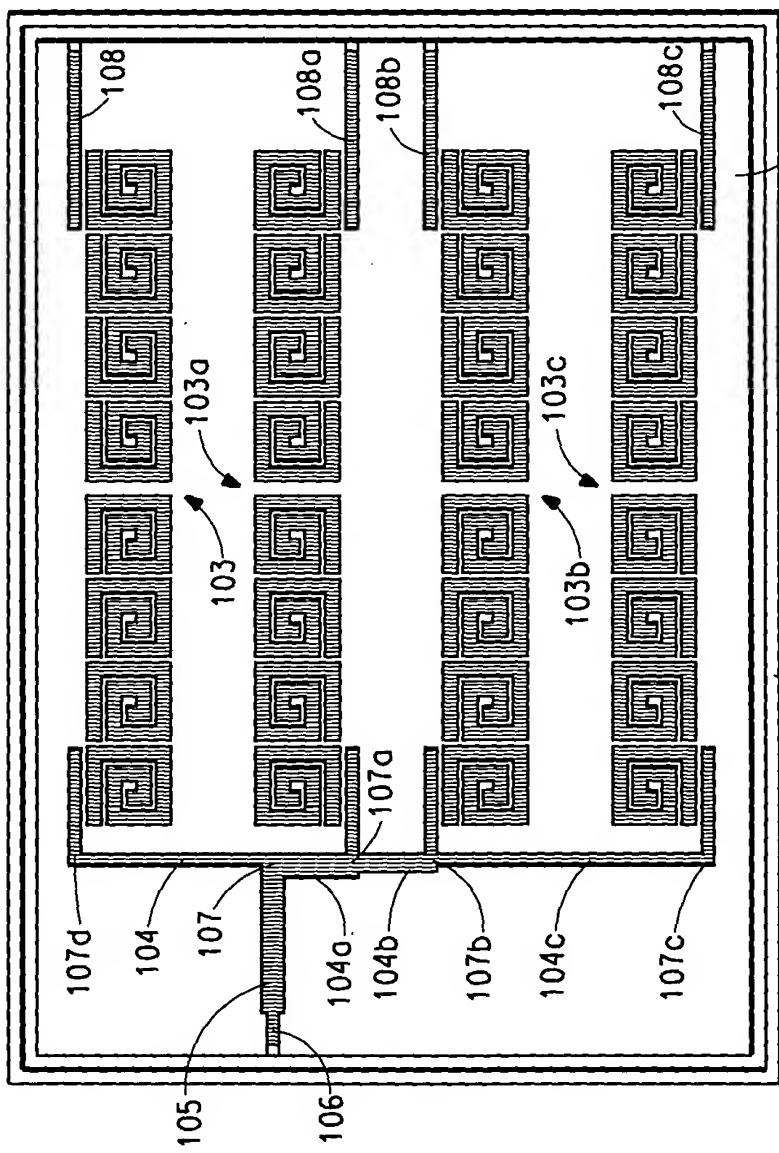


FIG. 10A

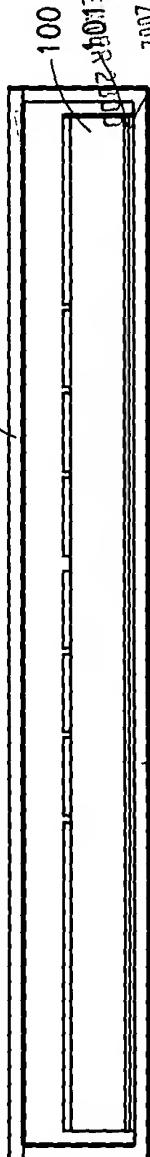


FIG. 10C



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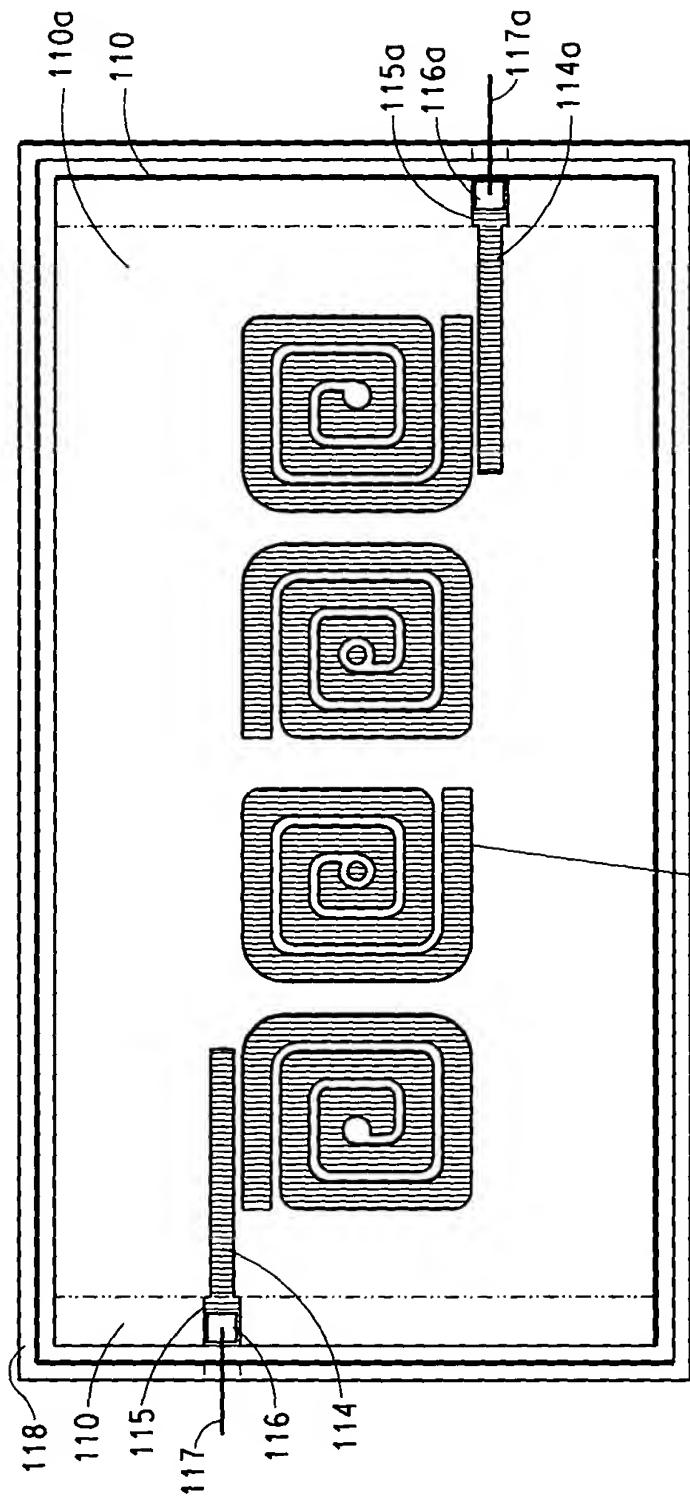


FIG. 11A

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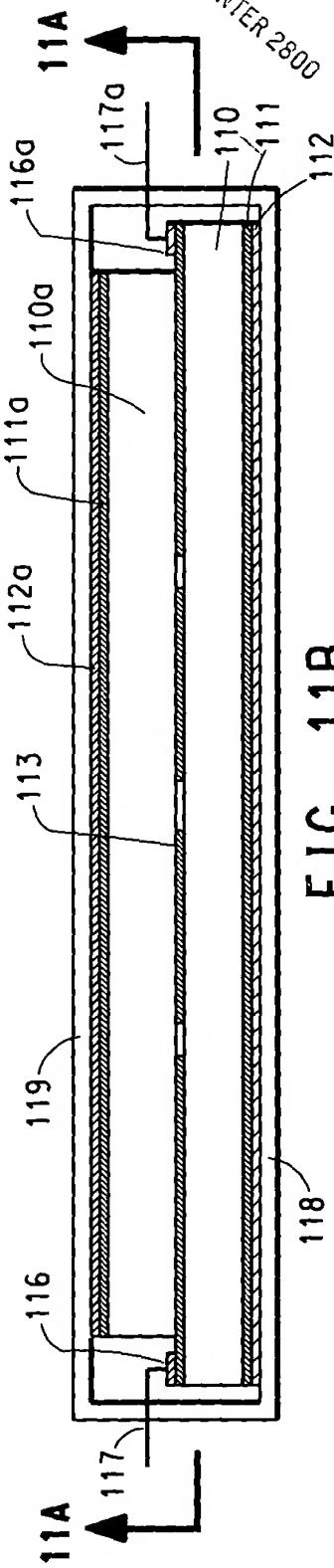


FIG. 11B